Ref #	Hits	Search Query	DBs	Default Operat or	Plural s	Time Stamp
L1	14	("3864728" "4320865" "530 2801" "5897341" "6265244 ").PN.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 19:55
L2	7	("3864728" "4320865" "530 2801" "5897341" "6265244 ").PN	US-PGPU B; USPAT; EPO; JPO; IBM_TDB	OR	ON	2006/11/09 19:55
L3	999	392/418,407.ccls.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 19:56
L4	391	228/256.ccls.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:36
L5	1390	3 or 4	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 19:58

11/9/2006 8:51:41 PM
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L9	15	5 and (solder\$3 or bump\$3) with((halogen adj lamp) or radiat\$3)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:10
L10	8	5 and ((solder\$3 or bump\$3) with ((form\$3 or flush\$3) near5 gas))	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:07
L11	26	5 and ((solder\$3 or bump\$3) and ((form\$3 or flush\$3) near5 gas))	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	·OR	ON	2006/11/09 20:22
L12	48	5 and ((solder\$3 or bump\$3) and ((halogen adj lamp) or radiat\$3))	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:10
L14	136	((solder\$3 or bump\$3)near5((form\$3 or flush\$3)adj gas))	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:50

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L15	605	228/33.ccls.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:39
L16	247	228/42.ccls.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:41
L17	87	228/261.ccls.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:39
L18	402	228/245.ccls.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:39
L19	2657	5 or 15 or 16 or 17 or 18	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:42

L20		19 and ((solder\$3 or bump\$3) and (halogen adj lamp))and ((induction or electric or electricity or current or voltage)adj heat\$3)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:50
L21	8	19 and((solder\$3 or bump\$3)near5((form\$3 or flush\$3)adj gas))	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2006/11/09 20:50